This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS

Claim 1 (Currently Amended) A polycarbonate resin composition, comprising: which comprises

a resin mixture of (A) and (B):

- (A) from 4 50 to 99 90 % by weight of a polycarbonate, and
- (B) from $\frac{10}{10}$ to $\frac{99}{50}$ % by weight of a thermoplastic polyester, and contains, relative to $\frac{100}{100}$ parts by weight of the said resin mixture of (A) and (B);
 - (C) from 0.01 to 3 parts by weight of a polyfluoro-olefin resin, and a mixture of (D) and (E);

wherein (D) is from 1 to 400 parts by weight of a polycarbonate-polyorganosiloxane copolymer; and/or

wherein (E) is from 0.1 to 10 parts by weight of a functional silicone compound, and of which the wherein a silicone content derived from the component (D) and/or the component (E) falls between 0.5 and 10 % by weight of the said resin composition.

Claim 2 (Withdrawn-Currently Amended) The polycarbonate resin composition as claimed in claim 1, which further contains comprising (F) from 1 to 50 parts by weight of an inorganic filler.

Claim 3 (Withdrawn) The polycarbonate resin composition as claimed in claim 1, wherein the functional silicone compound for the component (E) has a basic structure of a general formula (1):

$$R_a^1 R_b^2 SiO_{(4-a-b)/2}$$
 (1)

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wherein R¹ indicates a functional group, R² indicates a hydrocarbon residue having from 1 to 12 carbon atoms, and a and b are numbers satisfying the relations of $0 < a \le 3$, $0 \le b < 3$, and 0 < a + b < 3.

Claim 4. (Withdrawn-Currently Amended) The polycarbonate resin composition as claimed in claim 1, wherein the <u>a</u> functional group in the functional silicone compound for the component (E) is <u>at least one group</u> selected from <u>the group consisting of</u> an alkoxy group, a vinyl group, a hydrogen residue and an epoxy group.

Claim 5. (Withdrawn-Currently Amended) The polycarbonate resin composition as claimed in claim 1, wherein the <u>a</u> functional group in the functional silicone compound for the component (E) is a methoxy group or a vinyl group.

Claim 6. (Previously Presented) The polycarbonate resin composition as claimed in claim 1, wherein the polyfluoro-olefin resin for the component (C) is a fibril-forming polytetrafluoroethylene having a mean molecular weight of at least 500,000.

Claim 7. (Previously Presented) The polycarbonate resin composition as claimed in claim 1, wherein the polycarbonate for the component (A) has a viscosity-average molecular weight of from 15,000 to 20,000.

Claim 8. (Withdrawn) The polycarbonate resin composition as claimed in claim 2, wherein the inorganic filler for the component (F) is talc having a mean particle size of from 0.2 to 20 μ m.

Claim 9. (Previously Presented) Housings or parts of electric and electronic

appliances, which comprise the polycarbonate resin composition of claim 1.

Claim 10. (Withdrawn) The polycarbonate resin composition as claimed in claim 3,

wherein the inorganic filler for the component (F) is talc having a mean particle size of from

0.2 to 20 μm.

Claim 11. (Withdrawn) The polycarbonate resin composition as claimed in claim 4,

wherein the inorganic filler for the component (F) is talc having a mean particle size of from

0.2 to 20 μm.

Claim 12. (Withdrawn) The polycarbonate resin composition as claimed in claim 5,

wherein the inorganic filler for the component (F) is talc having a mean particle size of from

0.2 to 20 μm.

Claim 13. (Withdrawn) The polycarbonate resin composition as claimed in claim 6,

wherein the inorganic filler for the component (F) is talc having a mean particle size of from

0.2 to 20 μm.

Claim 14. (Withdrawn) The polycarbonate resin composition as claimed in claim 7,

wherein the inorganic filler for the component (F) is talc having a mean particle size of from

0.2 to $20 \mu m$.

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Claim 15 (New) A molding obtained from the polycarbonate resin composition as claimed in claim 1.

Claim 16 (New) The molding as claimed in claim 15, further comprising (F) from 1 to 50 parts by weight of an inorganic filler.

Claim 17 (New) The molding as claimed in claim 15, wherein the functional silicone compound for the component (E) has a basic structure of a general formula (1):

$$R_a^1 R_b^2 SiO_{(4-a-b)/2}$$
 (1)

wherein R^1 indicates a functional group, R^2 indicates a hydrocarbon residue having from 1 to 12 carbon atoms, and a and b are numbers satisfying the relations of $0 < a \le 3$, $0 \le b < 3$, and 0 < a + b < 3.

Claim 18. (New) The molding as claimed in claim 15, wherein a functional group in the functional silicone compound for the component (E) is at least one group selected from the group consisting of an alkoxy group, a vinyl group, a hydrogen residue and an epoxy group.

Claim 19. (New) The molding as claimed in claim 15, wherein the polyfluoro-olefin resin for the component (C) is a fibril-forming polytetrafluoroethylene having a mean molecular weight of at least 500,000.

Claim 20. (New) The molding as claimed in claim 15, wherein the polycarbonate for the component (A) has a viscosity-average molecular weight of from 15,000 to 20,000.

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BASIS FOR THE AMENDMENT

Claims 2 and 4 have been amended to better conform to accepted US claim format.

Claim 1 has been amended to be limited to the elected species and as further supported at page 12, 1st paragraph.

New Claims 15-20 have been added as supported at page 22, lines 7 and 6 from the bottom and by Claims 2-4 and 6-7 as originally filed.

No new matter is believed to have been added by entry of this amendment. Entry and favorable reconsideration are respectfully requested.

Upon entry of this amendment Claims 1-20 will be active in this application. Claims 2-5, 8 and 10-14 stand withdrawn from consideration as being drawn to non-elected subject matter.

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INTERVIEW SUMMARY

Applicants wish to thank Examiner Buttner for his helpful and courteous discussion with Applicants' Representative on August 19, 2003. During this discussion it was noted that Claim 1 would be allowable if it requires (D) and (E).